

## N-channel Enhancement Mode Power MOSFET

### Features

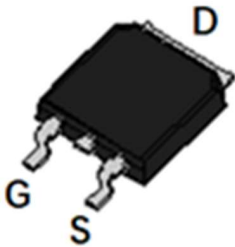
- $V_{DS} : 30V$  ,  $I_D : 100A$   
 $R_{DS(ON)} (typ) = 3.3m\Omega @ V_{GS} = 10V$   
 $R_{DS(ON)} (typ) = 4.2m\Omega @ V_{GS} = 4.5V$
- Advanced Trench Technology
- Provide Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead free product is acquired

### Application

- Load Switch
- PWM Application
- Power management



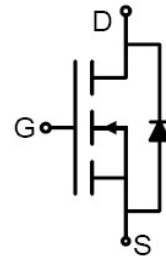
*100% UIS TESTED!*  
*100%  $\Delta V_{ds}$  TESTED!*



TO-252(DPAK) top view



Marking and pin Assignment



Schematic Diagram

## Package Marking and Ordering Information

|                           |                                                   |
|---------------------------|---------------------------------------------------|
| Part NO.                  | TF100N03A                                         |
| Marking1                  | 100N03A: TF100N03A                                |
| Marking2                  | TF:tuofeng; Y:year code; XX:Week; AA:device code; |
| Basic ordering unit (pcs) | 2500                                              |

## Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise specified)

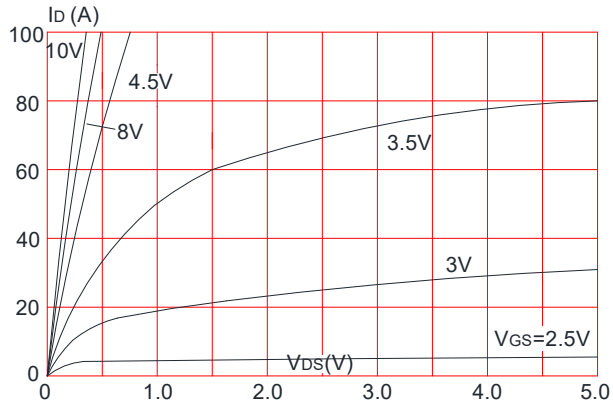
| Symbol                            | Parameter                                       |                        | Max.        | Units |
|-----------------------------------|-------------------------------------------------|------------------------|-------------|-------|
| V <sub>DSS</sub>                  | Drain-Source Voltage                            |                        | 30          | V     |
| V <sub>GSS</sub>                  | Gate-Source Voltage                             |                        | ±20         | V     |
| I <sub>D</sub>                    | Continuous Drain Current                        | T <sub>C</sub> = 25°C  | 100         | A     |
|                                   |                                                 | T <sub>C</sub> = 100°C | 65          | A     |
| I <sub>DM</sub>                   | Pulsed Drain Current <sup>note1</sup>           |                        | 300         | A     |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy <sup>note2</sup> |                        | 110         | mJ    |
| P <sub>D</sub>                    | Power Dissipation                               | T <sub>C</sub> = 25°C  | 70          | W     |
| R <sub>θJC</sub>                  | Thermal Resistance, Junction to Case            |                        | 2.50        | °C/W  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range         |                        | -55 to +175 | °C    |

**Electrical Characteristics** ( $T_J=25^{\circ}\text{C}$  unless otherwise specified)

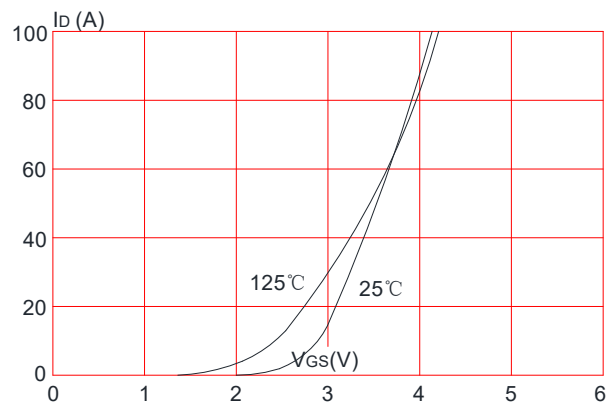
| Symbol                                                 | Parameter                                                 | Test Condition                                                                              | Min. | Typ. | Max. | Units |
|--------------------------------------------------------|-----------------------------------------------------------|---------------------------------------------------------------------------------------------|------|------|------|-------|
| Off Characteristic                                     |                                                           |                                                                                             |      |      |      |       |
| V <sub>(BR)DSS</sub>                                   | Drain-Source Breakdown Voltage                            | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                                  | 30   | -    | -    | V     |
| I <sub>DSS</sub>                                       | Zero Gate Voltage Drain Current                           | V <sub>DS</sub> =30V, V <sub>GS</sub> = 0V,                                                 | -    | -    | 1.0  | μA    |
| I <sub>GSS</sub>                                       | Gate to Body Leakage Current                              | V <sub>DS</sub> =0V, V <sub>GS</sub> = ±20V                                                 | -    | -    | ±100 | nA    |
| On Characteristics                                     |                                                           |                                                                                             |      |      |      |       |
| V <sub>GS(th)</sub>                                    | Gate Threshold Voltage                                    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA                                   | 1.0  | 1.5  | 2.5  | V     |
| R <sub>DS(on)</sub>                                    | Static Drain-Source on-Resistance<br><small>note3</small> | V <sub>GS</sub> =10V, I <sub>D</sub> =30A                                                   | -    | 3.3  | 4.0  | mΩ    |
|                                                        |                                                           | V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A                                                  | -    | 4.2  | 6.5  |       |
| Dynamic Characteristics                                |                                                           |                                                                                             |      |      |      |       |
| C <sub>iss</sub>                                       | Input Capacitance                                         | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V,<br>f = 1.0MHz                                    | -    | 2236 | -    | pF    |
| C <sub>oss</sub>                                       | Output Capacitance                                        |                                                                                             | -    | 323  | -    | pF    |
| C <sub>rss</sub>                                       | Reverse Transfer Capacitance                              |                                                                                             | -    | 234  | -    | pF    |
| Q <sub>g</sub>                                         | Total Gate Charge                                         | V <sub>DS</sub> =15V, I <sub>D</sub> =30A,<br>V <sub>GS</sub> =10V                          | -    | 42   | -    | nC    |
| Q <sub>gs</sub>                                        | Gate-Source Charge                                        |                                                                                             | -    | 5.7  | -    | nC    |
| Q <sub>gd</sub>                                        | Gate-Drain(“Miller”) Charge                               |                                                                                             | -    | 9.20 | -    | nC    |
| Switching Characteristics                              |                                                           |                                                                                             |      |      |      |       |
| t <sub>d(on)</sub>                                     | Turn-on Delay Time                                        | V <sub>DS</sub> =15V,<br>I <sub>D</sub> =30A, R <sub>GEN</sub> =3Ω,<br>V <sub>GS</sub> =10V | -    | 21   | -    | ns    |
| t <sub>r</sub>                                         | Turn-on Rise Time                                         |                                                                                             | -    | 27   | -    | ns    |
| t <sub>d(off)</sub>                                    | Turn-off Delay Time                                       |                                                                                             | -    | 68   | -    | ns    |
| t <sub>f</sub>                                         | Turn-off Fall Time                                        |                                                                                             | -    | 34   | -    | ns    |
| Drain-Source Diode Characteristics and Maximum Ratings |                                                           |                                                                                             |      |      |      |       |
| I <sub>S</sub>                                         | Maximum Continuous Drain to Source Diode Forward Current  |                                                                                             | -    | -    | 100  | A     |
| I <sub>SM</sub>                                        | Maximum Pulsed Drain to Source Diode Forward Current      |                                                                                             | -    | -    | 400  | A     |
| V <sub>SD</sub>                                        | Drain to Source Diode Forward Voltage                     | V <sub>GS</sub> = 0V, I <sub>S</sub> =30A                                                   | -    | -    | 1.2  | V     |
| t <sub>rr</sub>                                        | Body Diode Reverse Recovery Time                          | I <sub>F</sub> =20A,dI/dt=100A/μs                                                           | -    | 31   | -    | ns    |
| Q <sub>rr</sub>                                        | Body Diode Reverse Recovery Charge                        |                                                                                             | -    | 25   | -    | nC    |

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature  
 2. EAS condition:  $T_J=25^{\circ}\text{C}$ ,  $V_{DD}=20V$ ,  $V_G=10V$ ,  $R_G=25\Omega$ ,  $L=0.5Mh$ ,  $I_{AS}=20A$   
 3. Pulse Test: Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 0.5\%$

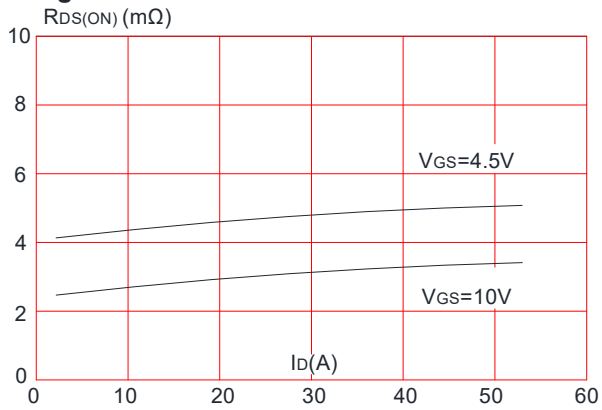
**Figure1: Output Characteristics**



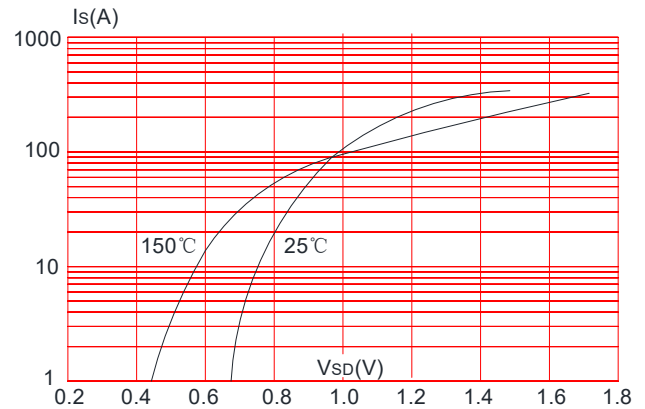
**Figure 2: Typical Transfer Characteristics**



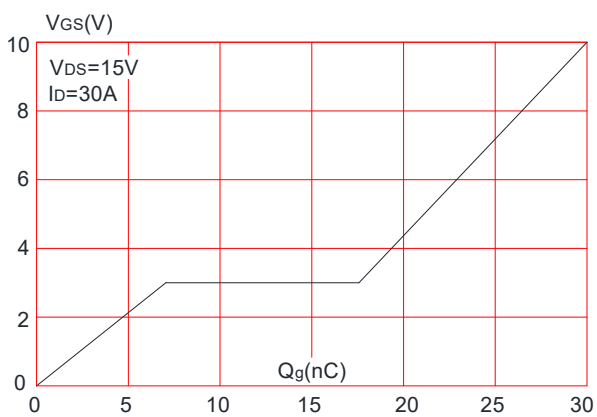
**Figure 3: On-resistance vs. Drain Current**



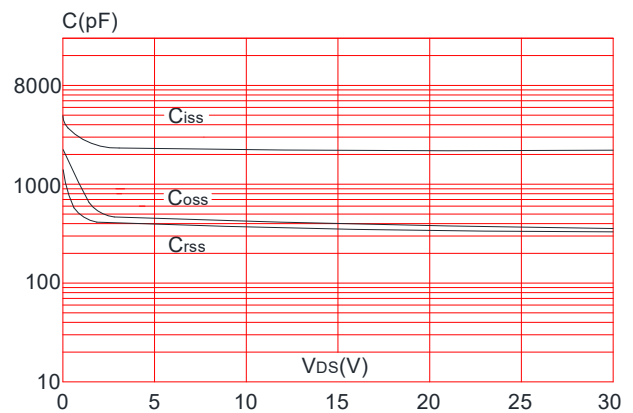
**Figure 4: Body Diode Characteristics**



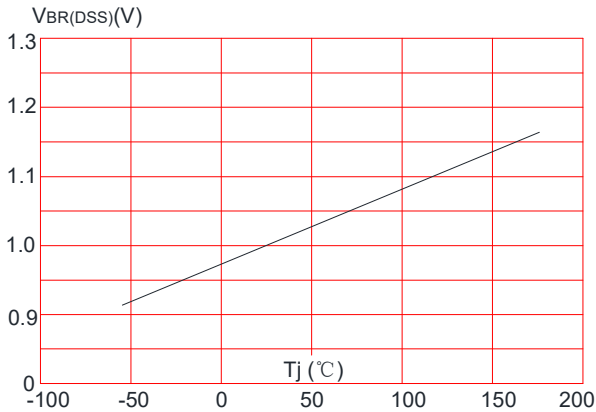
**Figure 5: Gate Charge Characteristics**



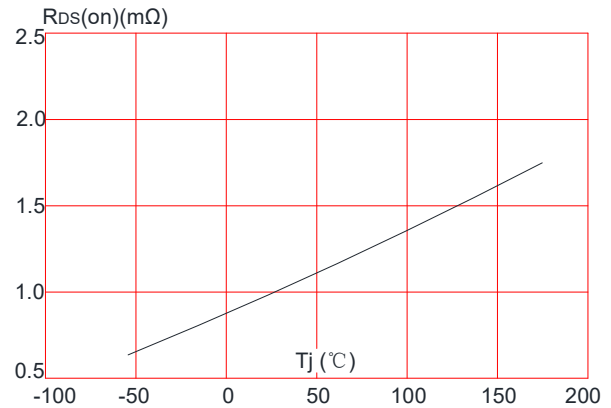
**Figure 6: Capacitance Characteristics**



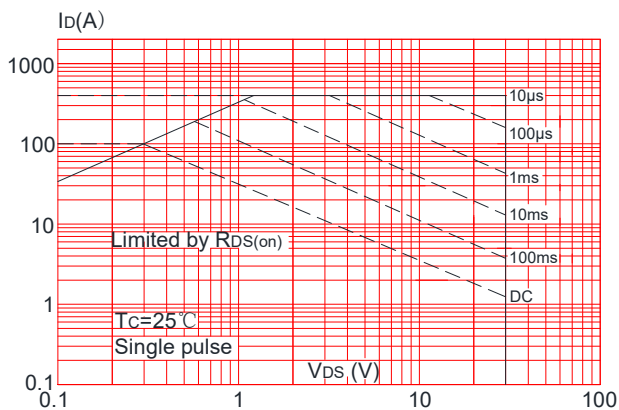
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



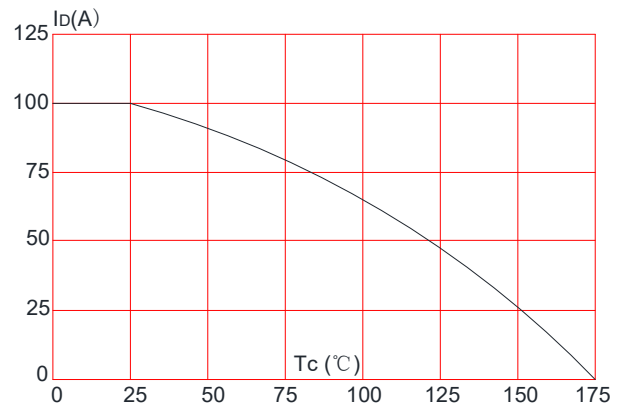
**Figure 8:** Normalized on Resistance vs. Junction Temperature



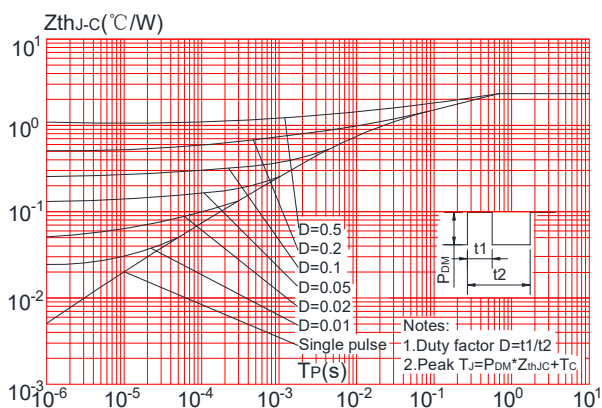
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature



**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



## Test Circuit

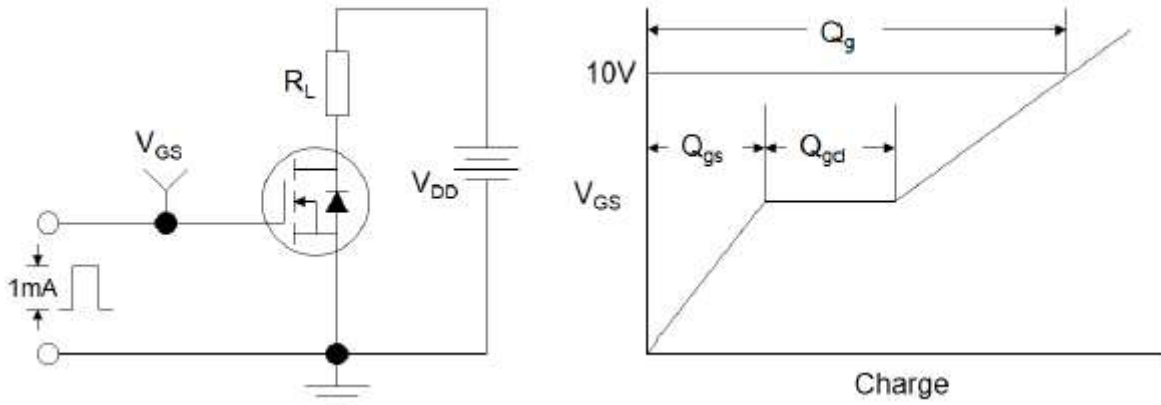


Figure1:Gate Charge Test Circuit & Waveform

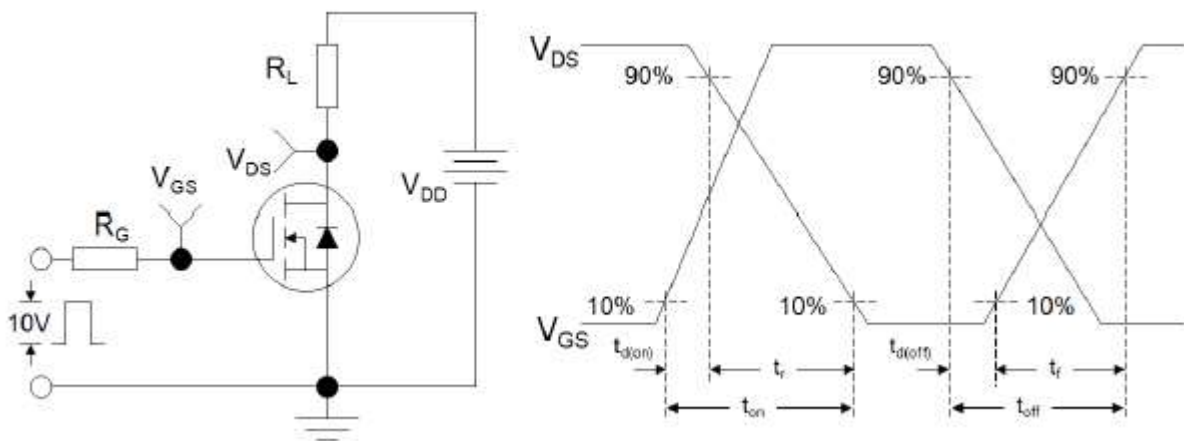


Figure 2: Resistive Switching Test Circuit & Waveforms

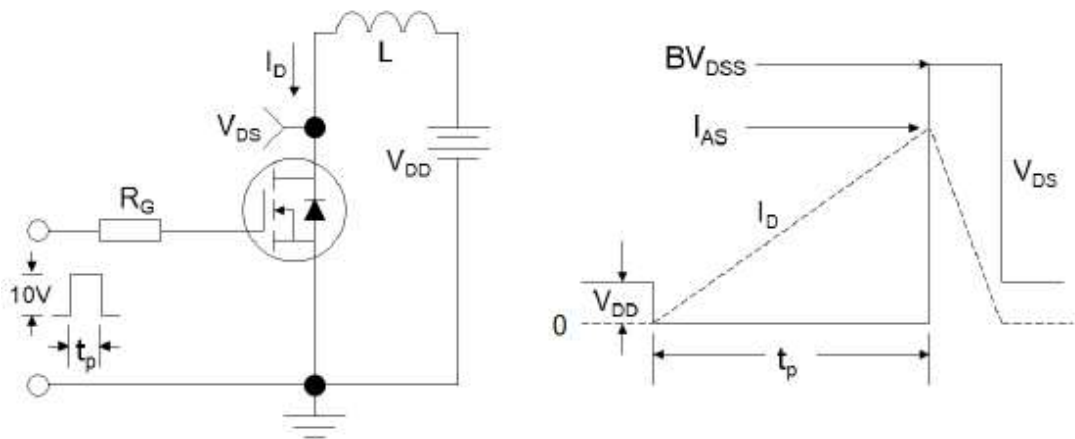
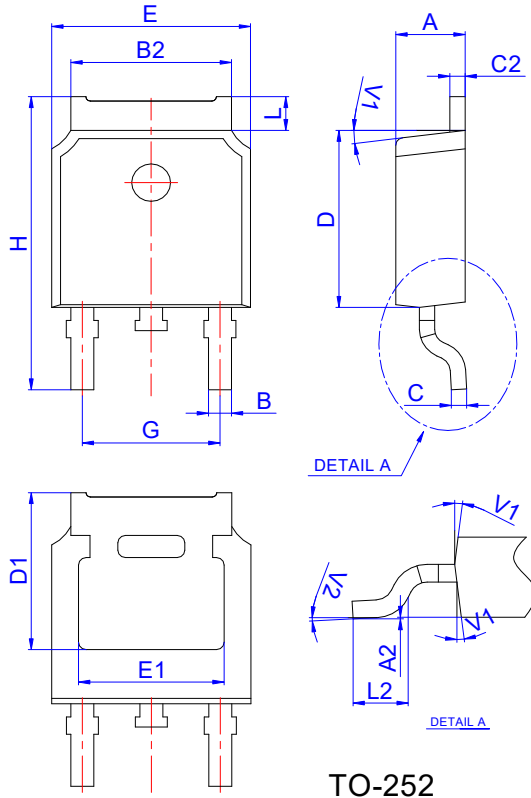


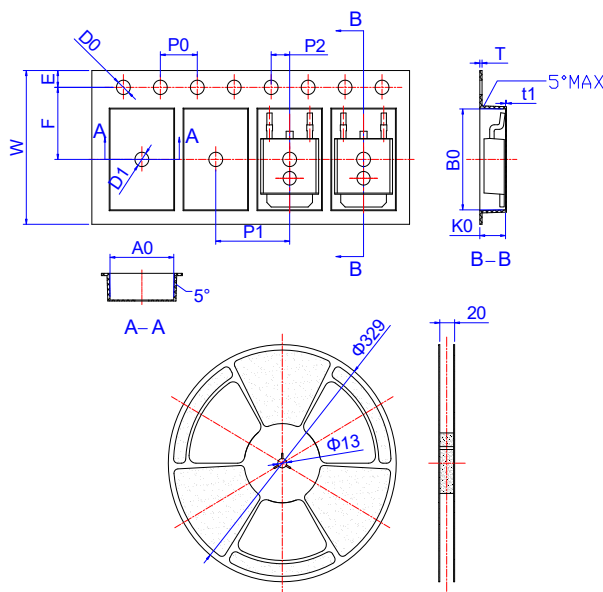
Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

## Package Mechanical Data-TO-252



| Ref. | Dimensions  |      |       |          |      |       |
|------|-------------|------|-------|----------|------|-------|
|      | Millimeters |      |       | Inches   |      |       |
|      | Min.        | Typ. | Max.  | Min.     | Typ. | Max.  |
| A    | 2.10        |      | 2.50  | 0.083    |      | 0.098 |
| A2   | 0           |      | 0.10  | 0        |      | 0.004 |
| B    | 0.66        |      | 0.86  | 0.026    |      | 0.034 |
| B2   | 5.18        |      | 5.48  | 0.202    |      | 0.216 |
| C    | 0.40        |      | 0.60  | 0.016    |      | 0.024 |
| C2   | 0.44        |      | 0.58  | 0.017    |      | 0.023 |
| D    | 5.90        |      | 6.30  | 0.232    |      | 0.248 |
| D1   | 5.30REF     |      |       | 0.209REF |      |       |
| E    | 6.40        |      | 6.80  | 0.252    |      | 0.268 |
| E1   | 4.63        |      |       | 0.182    |      |       |
| G    | 4.47        |      | 4.67  | 0.176    |      | 0.184 |
| H    | 9.50        |      | 10.70 | 0.374    |      | 0.421 |
| L    | 1.09        |      | 1.21  | 0.043    |      | 0.048 |
| L2   | 1.35        |      | 1.65  | 0.053    |      | 0.065 |
| V1   |             | 7°   |       |          | 7°   |       |
| V2   | 0°          |      | 6°    | 0°       |      | 6°    |

## Reel Specification-TO-252



| Ref. | Dimensions  |       |       |        |       |       |
|------|-------------|-------|-------|--------|-------|-------|
|      | Millimeters |       |       | Inches |       |       |
|      | Min.        | Typ.  | Max.  | Min.   | Typ.  | Max.  |
| W    | 15.90       | 16.00 | 16.10 | 0.626  | 0.630 | 0.634 |
| E    | 1.65        | 1.75  | 1.85  | 0.065  | 0.069 | 0.073 |
| F    | 7.40        | 7.50  | 7.60  | 0.291  | 0.295 | 0.299 |
| D0   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| D1   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| P0   | 3.90        | 4.00  | 4.10  | 0.154  | 0.157 | 0.161 |
| P1   | 7.90        | 8.00  | 8.10  | 0.311  | 0.315 | 0.319 |
| P2   | 1.90        | 2.00  | 2.10  | 0.075  | 0.079 | 0.083 |
| A0   | 6.85        | 6.90  | 7.00  | 0.270  | 0.271 | 0.276 |
| B0   | 10.45       | 10.50 | 10.60 | 0.411  | 0.413 | 0.417 |
| K0   | 2.68        | 2.78  | 2.88  | 0.105  | 0.109 | 0.113 |
| T    | 0.24        |       | 0.27  | 0.009  |       | 0.011 |
| t1   | 0.10        |       |       | 0.004  |       |       |
| 10P0 | 39.80       | 40.00 | 40.20 | 1.567  | 1.575 | 1.583 |